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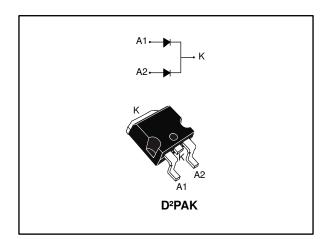






Automotive high efficiency ultrafast diode

Datasheet - production data



Features

- AEC-Q101 qualified
- Low losses
- Low forward and reverse recovery time
- Low leakage current
- High junction temperature
- V_{RRM} guaranteed from -40 to +175 °C
- PPAP capable

Description

Dual center tap rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in D²PAK, this device is especially intended for use in low voltage, high frequency inverters, freewheeling and polarity protection applications for automotive applications.

Table 1: Device summary

Symbol	Value
I _{F(AV)}	2 x 8 A
V_{RRM}	200 V
T _j (max.)	175 °C
V _F (typ.)	0.78 V
t _{rr} (typ.)	21 ns

Characteristics STTH1602C-Y

1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage (T _j =	-40 to +175 °C)		200	V
I _{F(RMS)}	Forward rms current			26	Α
	Average forward current δ = 0.5,	T _C = 150 °C	Per diode	8	
I _{F(AV)}	square wave	T _C = 140 °C	Per device	16	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinu	usoidal	100	Α
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature range -40 to +175			°C	

Table 3: Thermal parameter

Symbol	Parameter	Max. value	Unit	
D	Junction to case	Per diode	2.7	°C/W
R _{th(j-c)}	Junction to case	Per device	1.6	-0/00
R _{th(c)}	Coupling		0.5	°C/W

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \; x \; R_{th(j\text{-}c) \; (per \; diode)} \; + \; P_{(diode2)} \; x \; R_{th(c)}$

Table 4: Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
1 (1)	Doverse leeke se current	T _j = 25 °C	V _R = V _{RRM}	1		6	
IR ^(*)	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C		-	4	60	μΑ
	V (2)	T _j = 25 °C	I _F = 8 A	-		1.10	
V _F ⁽²⁾		T _j = 150 °C		-	0.78	0.90	V
V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	1 1C A	-		1.25	V	
		T _j = 150 °C	I _F = 16 A	-		1.05	

Notes:

 $^{(1)}\text{Pulse}$ test: t_p = 5 ms, δ < 2%

 $^{(2)}$ Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses, use the following equation:

 $P = 0.75 \text{ x } I_{F(AV)} + 0.01875 \text{ x } I_{F^2(RMS)}$

STTH1602C-Y Characteristics

Table 5: Dynamic electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I _F = 1 A, V _R = 30 V, dI _F /dt = 100 A/μs	-	21	26	ns
I _{RM}	Reverse recovery current	T _j = 125 °C	$I_F = 8 \text{ A},$ $V_R = 160 \text{ V},$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	8	10	Α

Characteristics STTH1602C-Y

Characteristics (curves) 1.1

Figure 1: Average forward power dissipation

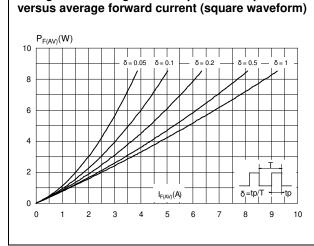


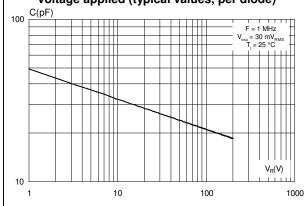
Figure 2: Forward voltage drop versus forward current (typical values) 100.0 T_j = 25 °C 1.0 $V_F(V)$ 0.1 0.5 1.0 0.0 1.5 2.0

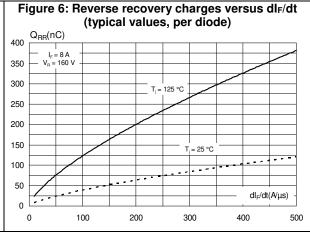
Figure 3: Forward voltage drop versus forward current (maximum values)

100.0 = 150 °C 10.0 T_j = 25 °C 1.0 V_F(V) 0.0 0.5 1.0 1.5 2.0 2.5

Figure 4: Relative variation of thermal impedance junction to case versus pulse duration Zth_(j-c)/Rth_(j-c) Single pulse D²PAK tp(s) 1.E-03 1.E-02 1.E-01 1.E+00

Figure 5: Junction capacitance versus reverse voltage applied (typical values, per diode)





STTH1602C-Y Characteristics

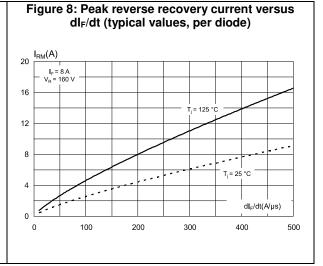
Figure 7: Reverse recovery time versus dlr/dt (typical values, per diode)

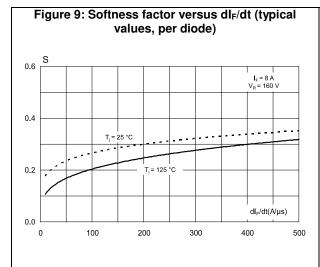
t_{RR}(ns)

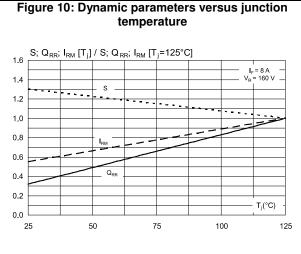
t_R = 8A

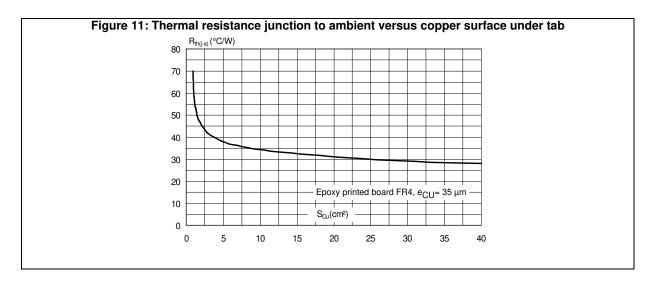
v_R = 160 v

d_R =









Package information STTH1602C-Y

2 Package information

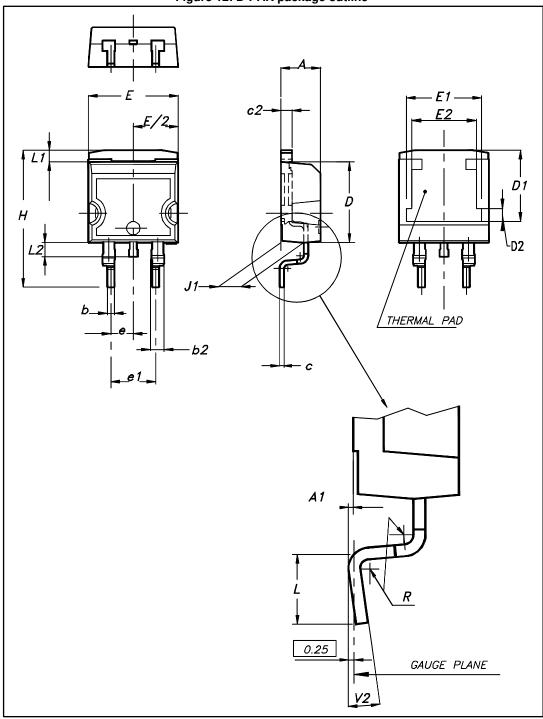
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL94,V0

STTH1602C-Y Package information

2.1 D²PAK package information

Figure 12: D²PAK package outline





This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 6: D²PAK package mechanical data

Dimensions				
Ref.	Millim	neters		hes
	Min.	Max.	Min.	Max.
А	4.36	4.60	0.172	0.181
A1	0.00	0.25	0.000	0.010
b	0.70	0.93	0.028	0.037
b2	1.14	1.70	0.045	0.067
С	0.38	0.69	0.015	0.027
c2	1.19	1.36	0.047	0.053
D	8.60	9.35	0.339	0.368
D1	6.90	8.00	0.272	0.311
D2	1.10	1.50	0.043	0.060
E	10.00	10.55	0.394	0.415
E1	8.10	8.90	0.319	0.346
E2	6.85	7.25	0.266	0.282
е	2.54	typ.	0.1	00
e1	4.88	5.28	0.190	0.205
Н	15.00	15.85	0.591	0.624
J1	2.49	2.90	0.097	0.112
L	1.90	2.79	0.075	0.110
L1	1.27	1.65	0.049	0.065
L2	1.30	1.78	0.050	0.070
R	0.4	typ.	0.0)15
V2	0°	8°	0°	8°

STTH1602C-Y Package information

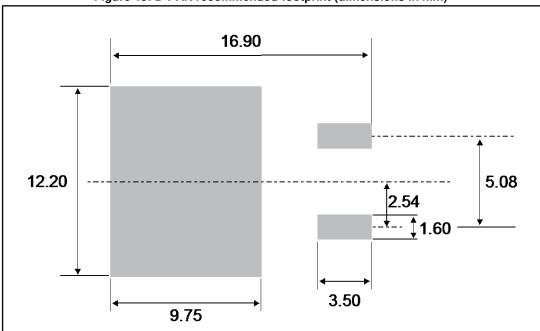


Figure 13: D²PAK recommended footprint (dimensions in mm)

Ordering information STTH1602C-Y

3 Ordering information

Table 7: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH1602CGY-TR	STTH1602CGY	D ² PAK	1.48 g	1000	Tape and reel

4 Revision history

Table 8: Document revision history

Date	Revision	Changes
04-Dec-2017	1	Initial release.

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